COMPONENT SPECIFICATION

M60 SERIES CONNECTORS

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PREPARED BY: Wend Bond

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COMPONENT SPECIFICATION M60 SERIES CONNECTORS

1. DESCRIPTION OF CONNECTOR AND INTENDED APPLICATION.

A selection of 0.8mm pitch connectors, comprising vertical surface mount plugs and sockets of varying heights. Board-to-board spacing is obtained by the selection of an appropriate height plug and socket.

2. MARKING OF THE CONNECTOR AND/OR PACKAGE (ORDER CODE).

The marking (order code) shall appear on the package and shall be of the following style:

| <u>M60</u> - <u>X</u> | $\underline{XX} \underline{XX} \underline{XX} \underline{XX}$ |
|--|---|
| Drochust Crown | |
| Product Group | |
| Connector Style | |
| No. of Ways per row | |
| Contact Finish | |
| | |
| Connector Style: | No. of Ways: |
| Surface Mount plug (4mm high) 604 | 10+10, 15+15, 20+20, 25+25, 30+30, |
| Surface Mount plug (5mm high) 605 | 40+40, 50+50 |
| Surface Mount plug (6mm high) 606 | , |
| Surface Mount socket (4mm high) 614 | Finish: |
| Surface Mount socket (6mm high) 616 | Selective Gold/Tin 22 |
| The batch code shall appear on the package and sha | all be of the following style: |
| XXX XX | X |
| Batch Number | |
| Week Number | |
| Year Number (last digit) | |
| i cai ivuilibei (last uigit) | _ |
| | |

The batch number is 001 to 999 repeated each week.

3. RATINGS.

3.1. MATERIAL & FINISH.

| Materials: | |
|------------|--|
| Mouldings | |
| Contacts | Phosphor Bronze |
| | Phosphor Bronze |
| Finish: | - |
| Contacts | |
| | Tin/lead on tails, over 1.27µ min Nickel |
| Fixtures | |

COMPONENT SPECIFICATION M60 SERIES CONNECTORS (continued)

3. RATINGS (continued).

3.2. ELECTRICAL CHARACTERISTICS.

| Rated Current | 0.5A AC/DC |
|---|--------------------------|
| Rated Voltage | |
| Maximum contact resistance (initial) | 40 mΩ |
| Maximum contact resistance (after conditioning) | |
| Dielectric Withstanding Voltage | 300V AC rms for 1 minute |
| Minimum insulation resistance | 1000 MΩ |
| | |

3.3. ENVIRONMENTAL CHARACTERISTICS.

| Temperature Range55°C to | o +100°C |
|--------------------------|----------|
|--------------------------|----------|

3.4. MECHANICAL CHARACTERISTICS.

| High temperature, short term (no electrical load) | 10 seconds at 260°C |
|--|---------------------|
| Maximum insertion force per contact (initial) | 1.0N |
| Maximum insertion force per contact (after 30 cycles) | |
| Minimum withdrawal force per contact (initial) | 0.1N |
| Minimum withdrawal force per contact (after 30 cycles) | 0.1N |

<u>COMPONENT SPECIFICATION</u> <u>M60 SERIES CONNECTORS (continued)</u>

APPENDIX A - TEST METHODS AND PERFORMANCE.

A1.1. TEST CONDITIONS.

Unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202:

| Temperature | 15° to 35°C |
|----------------------|---------------|
| Humidity | 45% to 75% RH |
| Atmospheric pressure | |

A1.2. TEST METHODS.

A1.2.1. Electrical.

i) Contact Resistance.

Solder a plug and a socket to PC Boards and mate them together. Measure the contact resistance using the 4-terminal method as shown in Figure 1. Apply the low-level condition of 20mV max. for the open circuit voltage, and 10mA DC max. for the closed circuit current. Contact resistance must not exceed the values stated in section 3.2.

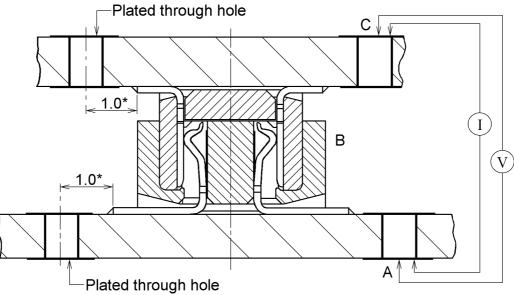


Figure 1: Contact Resistance

Note: Contact resistance is defined as R_{ABC} , i.e. the electrical resistance from point A on the back face of the lower PCB, through contact point B, to point C on the back face of the upper PCB. * = 2.0mm on the next line.

ii) Dielectric Withstanding Voltage.

Mate a plug and socket together (not soldered to a PC Board). Apply between neighbouring contacts a 300V AC rms current for 1 minute in accordance with MIL-STD-202, Method 301. No creeping discharge, flash-over or insulator break-down is allowed.

iii) Insulation Resistance.

Mate a plug and socket together (not soldered to a PC Board). Apply between neighbouring contacts a 100V DC voltage. Measurement is taken in accordance with MIL-STD-202, Method 302. Insulation resistance must not be less than the value stated in section 3.2.

<u>COMPONENT SPECIFICATION</u> <u>M60 SERIES CONNECTORS (continued)</u>

APPENDIX A - TEST METHODS AND PERFORMANCE (continued).

A1.2. TEST METHODS (continued).

A1.2.2. Environmental.

i) Thermal Shock.

Solder a plug and a socket to PC Boards and mate them together. Expose the mated connectors to the following environment:

| Temperature | $\dots -55^{\circ} (30 \text{ min.}) \rightarrow +85^{\circ}\text{C} (30 \text{ min.})$ |
|---|---|
| Transition time | |
| Number of cycles | |
| Contact resistance before and after the test must meet th | |
| damage affecting the performance must not occur. | |

ii) Humidity.

| Solder a plug and a socket to PC Boards and mate them together. Expose the mated connectors to | | |
|--|--|--|
| the following environment in accordance with MIL-STD-202, Method 103 Condition B: | | |
| Temperature | | |
| Humidity 90% to 95% RH | | |
| Duration | | |
| Contact resistance before and after the test must meet the values stated in section 3.2. | | |

iii) Salt Spray.

Contact resistance before and after the test must meet the values stated in section 3.2. Detrimental damage affecting the performance must not occur.

iv) Gas.

Solder a plug and a socket to PC Boards and mate them together. Expose the mated connectors to the following environment:

| Chamber temperature | 25° ±2°C |
|---------------------|----------|
| Humidity | 75% RH |
| Gas | |
| Duration | |
| | |

Contact resistance before and after the test must meet the values stated in section 3.2. Detrimental damage affecting the performance must not occur.

<u>COMPONENT SPECIFICATION</u> M60 SERIES CONNECTORS (continued)

APPENDIX A - TEST METHODS AND PERFORMANCE (continued).

A1.2. TEST METHODS (continued).

A1.2.2. Environmental (continued).

v) Vibration.

Solder a plug and a socket to PC Boards and mate them together. Place the mated connectors on a vibrator machine, and apply the following vibration in accordance with MIL-STD-202, Method 201. Care should be taken to fix the boards firmly to the vibrator machine to avoid any unnecessary resonance of the boards. During the testing, run a 100mA DC current to check for any electrical discontinuity. The test cycle must cover the following parameters:

- a) Frequency...... $10Hz \rightarrow 55Hz \rightarrow 10Hz$ over 1 minute approx.
- b) Directions...... Three mutually perpendicular directions
- d) Sweep duration Two hours for each direction, totalling 6 hours.

Contact resistance before and after testing must meet the values specified in section 3.2. No electrical discontinuity greater than 10 µseconds must occur during testing. Looseness amongst parts, chipping, breakage or other detrimental damage must not occur.

vi) Shock.

Solder a plug and a socket to PC Boards and mate them together. Place the mated connectors on a shock machine, and apply the following shock in accordance with MIL-STD-202, Method 213 Condition A. Care should be taken to fix the boards firmly to the shock machine to avoid any unnecessary resonance of the boards. During the testing, run a 100mA DC current to check for any electrical discontinuity. The test cycle must cover the following parameters:

- c) Wave form Half-sinusoidal

No electrical discontinuity greater than 10 µseconds must occur during testing. Looseness amongst parts, chipping, breakage or other detrimental damage must not occur.

vii) Solderability.

Dip the solder tine of a plug and socket connector in a flux of RMA or R type for 5 to 10 seconds. Then dip the tine into a solder bath $(245^{\circ} \pm 5^{\circ}C)$ for 5 ± 0.5 seconds. This test is in accordance with MIL-STD-202, Method 208. More than 95% of the dipped surface must be evenly wet.

A1.2.3. Mechanical.

i) Repeated Insertion/Withdrawal Force.

Solder a plug and a socket to PC Boards. Place the boards onto a push-on/pull-off machine. Repeat insertion and withdrawal for 30 cycles, at a speed of 25 ± 3 mm/min. along the mating axis. Insertion and withdrawal forces before and after the test must conform to those stated in section 3.4.

ii) Electrical Continuity Durability.

Solder a plug and a socket to PC Boards. Place the boards onto a push-on/pull-off machine. Repeat insertion and withdrawal for 30 cycles, at a speed of 25 ± 3 mm/min. along the mating axis. Contact resistance before and after the test must meet the values stated in section 3.2.